

(2.54 mm) .100"

ICF-640-S-O

ICF-328-T-O

ICF-314-S-O

ICF SERIES

SURFACE MOUNT DIP SOCKET

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?ICF

Insulator Material:

Black Liquid Crystal Polymer

Contact Material:

BeCu

Plating:

Sn or Au over

50 μ " (1.27 μ m) Ni

Operating Temp Range:

-55 °C to +125 °C

Insertion Depth:

(2.54 mm) .100" to

(3.81 mm) .150"

Insertion Force/Contact:

(1.39 N) 5 oz average

Withdrawal Force/Contact:

(1.11 N) 4 oz average

RoHS Compliant:

Yes

PROCESSING

Lead-Free Solderable:

Yes

SMT Lead Coplanarity:

(0.15 mm) .006" max*

*(.004" stencil solution may be available; contact IPG@samtec.com)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



TYPE SOCKET

ICF
=Surface Mount
IC Socket

ROW SPACING & NO. OF CONTACTS

PLATING OPTION

-S
=30 μ " (0.76 μ m)
Gold on contact,
Matte Tin on tail

-T
= Matte Tin

TAIL OPTION

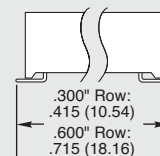
OTHER OPTION

-TR
=Tape &
Reel
Packaging

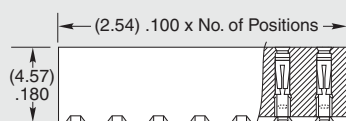
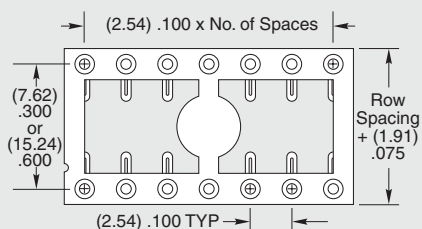
-I
=Tails In



-O
=Tails Out



Specify from chart below



"-XXX"	Row Space	No. of Contacts
-308	(7.62) .300	08
-314		14
-316		16
-318		18
-320		20
-328	(15.24) .600	28
-624		24
-628		28
-632		32
-640		40

Note:
Some sizes, styles and options are non-standard, non-returnable.

Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM

All parts within this catalog are built to Samtec's specifications.

Customer specific requirements must be approved by Samtec and identified in a Samtec customer-specific drawing to apply.